501874180 04/02/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Bo-Jr HUANG	03/22/2012
Yi-Wei CHEN	03/22/2012
Kuan-Yu LIN	03/22/2012
Chin-Chou LIU	03/22/2012

RECEIVING PARTY DATA

Name:	Taiwan Semiconductor Manufacturing Co., Ltd.	
Street Address:	No. 8, Li-Hsin Road 6	
Internal Address:	Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13437047

CORRESPONDENCE DATA

Fax Number: (215)689-4905 Phone: 215-979-1000

Email: jsjiulianti@duanemorris.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: DUANE MORRIS LLP (TSMC) IP DEPARTMENT

Address Line 1: 30 SOUTH 17TH STREET

Address Line 4: PHILADELPHIA, PENNSYLVANIA 19103-4196

ATTORNEY DOCKET NUMBER:	N1085-00952
NAME OF SUBMITTER:	Stephan P. Gribok

REEL: 027969 FRAME: 0592

PATENT

Total Attachments: 4

source=EXECUTEDASSIGN#page1.tif source=EXECUTEDASSIGN#page2.tif source=EXECUTEDASSIGN#page3.tif

source=EXECUTEDASSIGN#page4.tif

PATENT REEL: 027969 FRAME: 0593 Serial No. 13/437,047 filed April 2, 2012

ATTORNEY DOCKET NO.: 2011.1231/1085.952

ASSIGNMENT AND AGREEMENT

For value received, we, Bo-Jr HUANG, Yi-Wei CHEN, Kuan-Yu LIN and Chin-Chou LIU, hereby transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to POWER LINE FILTER FOR MULTIDIMENSIONAL INTEGRATED CIRCUITS, described in a non-provisional application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

- 1 -

DM2\3156159.1

ATTORNEY DOCKET NO.: 2011.1231/1085.952

We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: Mar. 23 / 20 12

Bo-To tlugues
Bo-Jr HUANG

Residence:

No. 11, Qigu, Qigu District, Tainan City 724, Taiwan, R.O.C.

Inventor No. 2

Dated: 3.22, 2012

Y I-WEI CHEN

Residence:

No. 3, Lane 9, Tianjin 1st Street, Taichung City 404, Taiwan, R.O.C.

Inventor No. 3

Dated: 3,22,2012

<u>Kuan-Yu Lin</u> Kuan-Yu LIN

Residence:

No. 3, Lane 6, Wufeng 1st Road, Zhudong Township, Hsinchu County 310, Taiwan, R.O.C.

-2-

DM2\3156159.1

bjhuangu 2012/03/22 10:52:09

ATTORNEY DOCKET NO.: 2011.1231/1085.952

Inventor No. 4

Dated: Mar 22, 2012

Chin-Chou LIU

Residence:

No. 28, Alley 16, Lane 50, Singuo Street, Jhubei City, Hsinchu County 302, Taiwan, R.O.C.

- 3 -

DM2\3156159.1

PATENT REEL: 027969 FRAME: 0596

PATENT REEL: 027969 FRAME: 0597

RECORDED: 04/02/2012